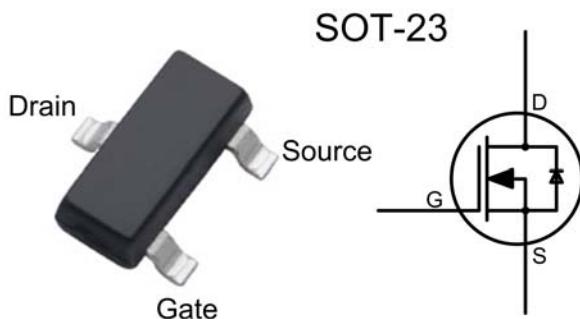


Depletion-Mode Power MOSFET

General Features

- ESD improved Capability
- Depletion Mode (Normally On)
- Proprietary Advanced Planar Technology
- Rugged Polysilicon Gate Cell Structure
- Fast Switching Speed
- RoHS Compliant
- Halogen-free available

BV_{DSX}	R_{DS(ON)} (Max.)	I_{DSS,min}
600V	120 Ω	100mA



Applications

- Normally-on Switches
- SMPS Start-up Circuit
- Linear Amplifier
- Converters
- Constant Current Source
- Telecom

Ordering Information

Part Number	Package	Marking	Remark
DMZ6012E	SOT-23	612	Halogen Free

Absolute Maximum Ratings

T_A=25°C unless otherwise specified

Symbol	Parameter	DMZ6012E	Unit
V _{DSX}	Drain-to-Source Voltage ^[1]	600	V
V _{DGX}	Drain-to-Gate Voltage ^[1]	600	V
I _D	Continuous Drain Current	0.1	A
I _{DM}	Pulsed Drain Current ^[2]	0.4	
P _D	Power Dissipation	0.50	W
V _{GS}	Gate-to-Source Voltage	±20	V
T _L	Soldering Temperature Distance of 1.6mm from case for 10 seconds	300	°C
T _J and T _{STG}	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	DMZ6012E	Unit
R _{θJA}	Thermal Resistance, Junction-to-Ambient	250	K/W

Electrical Characteristics

OFF Characteristics

$T_A = 25^\circ C$ unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
BV_{DSX}	Drain-to-Source Breakdown Voltage	600	--	--	V	$V_{GS}=-5V, I_D=250\mu A$
$I_{D(OFF)}$	Drain-to-Source Leakage Current	--	--	0.1	μA	$V_{DS}=600V, V_{GS}=-5V$
		--	--	10	μA	$V_{DS}=600V, V_{GS}=-5V$ $T_J=125^\circ C$
I_{GSS}	Gate-to-Source Leakage Current	--	--	20	μA	$V_{GS}=+20V, V_{DS}=0V$
		--	--	20		$V_{GS}=-20V, V_{DS}=0V$

ON Characteristics

$T_A = 25^\circ C$ unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
I_{DSS}	Saturated Drain-to-Source Current	100	--	130	mA	$V_{GS}=0V, V_{DS}=25V$
$R_{DS(ON)}$	Static Drain-to-Source On-Resistance	--	110	120	Ω	$V_{GS}=0V, I_D=50mA^{[3]}$
$V_{GS(OFF)}$	Gate-to-Source Cut-off Voltage	-3.0	--	-1.8	V	$V_{DS}=3V, I_D=8\mu A$
g_{fs}	Forward Transconductance	--	--	--	mS	$V_{DS}=10V, I_D=5mA$

Dynamic Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
C_{ISS}	Input Capacitance	--	--	--	pF	$V_{GS}=-5V$ $V_{DS}=25V$ $f=1.0MHz$
C_{OSS}	Output Capacitance	--	--	--		
C_{RSS}	Reverse Transfer Capacitance	--	--	--		
Q_G	Total Gate Charge	--	--	--	nC	$V_{GS}=-5V \sim 5V$ $V_{DS}=300V, I_D=7mA$
Q_{GS}	Gate-to-Source Charge	--	--	--		
Q_{GD}	Gate-to-Drain (Miller) Charge	--	--	--		

Resistive Switching Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$t_{d(ON)}$	Turn-on Delay Time	--	--	--	ns	$V_{GS} = -5V \sim 5V$ $V_{DD} = 300V, I_D=7mA$ $R_G = 20\Omega$
t_{rise}	Rise Time	--	--	--		
$t_{d(OFF)}$	Turn-off Delay Time	--	--	--		
t_{fall}	Fall Time	--	--	--		



DMZ6012E

Source-Drain Diode Characteristics

 $T_A=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Min	Typ.	Max.	Units	Test Conditions
V_{SD}	Diode Forward Voltage	--	--	1.2	V	$I_{SD}=100 \text{ mA}$, $V_{GS} = -10 \text{ V}$

NOTE:

[1] $T_J=+25^\circ\text{C}$ to $+150^\circ\text{C}$

[2] Repetitive rating, pulse width limited by maximum junction temperature.

[3] Pulse width $\leq 380\mu\text{s}$; duty cycle $\leq 2\%$.

Package Dimensions

SOT-23

